## SERVIICE AND OPERATION MANUAL

## MTG-1902EN OPEN FRAME S/VGA COLOR MONITOR

19" : 49-1337 - VP2


Information in this publication current as of Oct, 2003.
Information subject to change as display technology advance.
This publication produced by TOVIS Engineering Division.

This monitor has been designed and manufactured to deliver high performance video. For continued peak Performance use safe operation, only high quality TOVIS replacement parts or their exact specified Equivalent When servicing.

## SAFETY PRECAUTIONS AND WARNINGS

## Service Warning

This display contains HIGH VOLTAGE capable of delivering LETHAL quantities of energy.Service should only be attempted by trained personnel familiar with the potential dangers inherent with voltage equipment.

## Safety Related Component Warning

Certain components used in TOVIS color monitors are critical for safe operation of the display. These parts Number are marked by ( $\triangle$ ) in the parts list and on the schematic diagram it is essential that these Safety critical components be replaced only with exactly specified components to prevent the Possibility of excessive X-radiation emission, electrical shock, fire, or premature component failure.
Modifying the original design without written approval from TOVIS is expressly forbidden, will void the original Parts and labor warranty, and may result in creating a hazardous situation.

## X-Radiation Warning

COMPONENTS WHICH MAY AFFECT POTENTIAL EXCESS EMISSION OF X-RADIATION IN THE HORIZONTAL DEFLECTION AND HIGH VOLTAGE CIRCUITS (INCLUDING THE PICTURE TUBE) ARE TO BE USE ONLY TYPE AND RATING OF REPLACEMENT COMPONENT AS SHOWN IN THE PARTS LIST.

1. The only potential source of X -radiation emission is the picture tube. When the high voltage and horizontal deflection circuits are operating correctly there is no possibility of excess X -radiation emission. NEVER attempt to modify these circuits.
2. Periodically check the high voltage with a reliably calibrated meter for values not in excess of manufacture recommendations. See High Voltage Shut-down Circuit, page 4, for further details.

## CRT Warning

All picture tubes used in TOVIS monitors are equipped with an integral implosion protection system. The picture Tube is, however, a highly evacuated component whose outside surfaces are subject to strong external forces. Care must be exercised so as not to bump or scratch the tube during installation or servicing as this may cause the tube to implode resulting in possible personal injury and property damage. Shatter-proof goggles must be worn by Individuals while handling the CRT or installing the display in the cabinet. Do not handle The CRT by the neck.

1. Always ensure the high voltage at the anode cap is fully discharged prior to handling or service.
2. Replace picture tube only with same type and number.

## Product Safety and Service Guidelines

1. Service should be performed only after reading all the warnings and precautions in this manual and as Labeled on the CRT and chassis.
2. Where a short circuit has occurred, replace all components that indicate evidence of overheating or poor Connection on all plastic connectors.
3. Inspect wiring for frayed leads and damaged insulation when service is required, observe original lead Dress is followed as from the factory, especially in the high voltage circuitry area.
4. All protective devices must be reinstalled per original design.

## 1. Power Supply

Power Input: 90VAC ~ 264VAC, 60/50Hz
Fuse Rating: 250V, 50T 3.15A
Power Consumption: 120W Max

## 2. Signal Input

Video Input: Analog, Positive Signal ( 0.7 V p-p)
Horizontal Sync: TTL Level, Positive
or Negative Pulse
Horizontal Scan: 30KHz ~ 38KHz
Vertical Input: TTL Level, Positive or Negative Pulse
Vertical Scan: $50 \mathrm{~Hz} \sim 160 \mathrm{~Hz}$
Resolution-Mode

| Hf | Vf | Resolution | H Range | V range |
| :--- | :--- | :---: | :--- | :--- |
| 31 KHz | 70 Hz | $720 \times 400$ |  |  |
| 31 KHz | 60 Hz | $640 \times 480$ | $+/-1 \mathrm{KHz}$ | $50 \sim 160 \mathrm{~Hz}$ |
| 38 KHz | 60 Hz | $800 \times 600$ |  |  |

## 3. Picture Tube

Size: 19"
Dot Pitch: 0.82mm
Phosphor: P22

## 4. Leakage Current

To chassis ground, at 220VAC, 50 Hz (Line/Neut in common)

- 0.195mA Maximum


## 5. High Pot

Line/Neut in common to secondary/chassis,
1500VAC 60 Hz for 1 second

- 2.0mA Maximum, No Breakdown


## 6. Non-Linearity

Using a vertical and horizontal symmetrical cross hatch pattern to equation for non-linearity will be
Non-linearity (\%) $=(($ largest grid minus the smallestgrid $)$ Divided by (largest grid plus the Smallest grid)) times 100.

- 8\% Maximum


## 7. Temperature

Operating: $10^{\circ} \sim 50^{\circ} \mathrm{C}$
Storage: $-10^{\circ} \mathrm{C} \sim 75^{\circ} \mathrm{C}$

Humidity: 10\% ~ 90\%(Non-condensing)

## 8. Power Save Mode

Shall be initiated by holding the Vertical Sync input Low ( 0.5 V ) and shall reduce the power to less than20 Watts.

## 9. Degaussing

Automatic at power-up and software via control Switch "SEL"

## 10. Regulation (Static)

The horizontal and vertical size will change less than 2 mm for a $25 \%$ white level abrupt luminance change.

## 11. Display Stability for Temperature

The temperature is cycled from $25^{\circ} \mathrm{C}$ to $0^{\circ} \mathrm{C}$, and from $25^{\circ} \mathrm{C}$ to $50^{\circ} \mathrm{C}$ the video size and centering drift will not exceed 5 mm horizontally or 4 mm vertically.
(Measured after a 20 min . warm-up period at $25^{\circ} \mathrm{C}$ )
12. Monitor Test Specifications

| Parameter | Nominal | Specification |
| :--- | :--- | :--- |
| H/V |  |  |
| (0BÀ Beam Current) | 24.5 KV | $+/-500 \mathrm{~V}$ |
| G2 | 400 V DC | $+/-10 \mathrm{~V}$ |
| Brightness | 0.35 Ft | $+/-0.15 \mathrm{Ft}$ |
| Contrast |  |  |
| (15\% Window Box) | 60.0 Ft | $+/-5 \mathrm{Ft}$ |
| White Balance (9300) | $\mathrm{X}: 0.281$ | $+/-0.015$ |
|  | $\mathrm{Y}: 0.311$ | $+/-0.015$ |
| White Balance (6500) | $\mathrm{X}: 0.313$ | $+/-0.015$ |
|  | $\mathrm{Y}: 0.329$ | $+/-0.015$ |

Test Mode: VGA 640x 480(Fh: 31KHz, Fv: 60Hz) Signal: BSG-170 (BARO)

## 13. WARRANTY

Manufacturer warranty 2 years parts and labor. (Except on C.R.T)

There are four switches on the control panel. Adjustable controls allow the best display status for individual preferences

## Key Function

(1) MODE

MODE - Call the Main-Menu OSD.
(2) SEL/DEGAUSS

SEL - Select the function (sub-Menu OSD) on the Main- Menu OSD.
DEGAUSS - Do degaussing in state that the OSD isn't displayed.
(3) DOWN/UP

When the Main - Menu is displayed, can search each function using these keys. When the Sub - Menu is displayed (after select the function), can change each state of the screen using these keys.

## O.S.D Control Sub-P.C.B



## O.S.D CONTROL METHOD

1) Control items.

| Location | Adjustment <br> Method | Function |
| :--- | :--- | :--- |
|  |  | Brightness <br> Contrast <br> HorizontalPosition <br> Horizontal-Size <br> Vertical Position <br> SUB PCB |
|  | OSD Control |  |
|  |  | Vertical-Size <br> Pincushion <br> Trapezoid <br> Parallelog <br> Pin balance <br> Parallelogram |
|  | VR Control, | Sub-Bright <br> H.V Adjustment <br> MAIN PCB |
|  | VR502, | VR501, FBT |
|  | H-Sub Size <br> Focus and Screen |  |

## O.S.D Controls

: User's control.

## A. BRIGHTNESS ADJUSTMENT

1) Press the "MODE" key then Main-Menu OSD come out as below Figure.
2) Search "BRIGHTNESS" sub-menu using "UP/DOWN" key on the Main-Menu OSD.
3) Select the "BRIGHTNESS" by pressing "SEL" key. Then The "BRIGHTNESS" OSD color changes from yellow to red.
4) Search "BRIGHTNESS" sub-menu using "UP/DOWN" key on the Main-Menu OSD.
5) Select the "BRIGHTNESS" by pressing "SEL" key. Then The "BRIGHTNESS" OSD color changes fromBlue to red.
6) Adjust Brightness as much as you want using "UP/DOWN" key.
7) After finish the Brightness adjust, Press the "MODE" key then the "BRIGHTNESS" OSD color changes from red to blue and changed brightness value saved automatically.
8) If you want to adjust other function (submenu), Search your wanting sub-menu like "CONTRAST" using "UF then adjusts as same 4) and 5).
9) Press the "MODE" key


| B. CONTRAST | ADJUST AS SAME WAY AS ABOVE |
| :--- | :--- |
| C. H.POSITION | ADJUST AS SAME WAY AS ABOVE |
| D. H-SIZE | ADJUST AS SAME WAY AS ABOVE |
| E. V.POSITION | ADJUST AS SAME WAY AS ABOVE |
| F. V-SIZE | ADJUST AS SAME WAY AS ABOVE |
| H. PINCUSHION | ADJUST AS SAME WAY AS ABOVE |
| I. TRAPEZOID | ADJUST AS SAME WAY AS ABOVE |
| J. PARALLELOG | ADJUST AS SAME WAY AS ABOVE |
| K. PINBALANCE | ADJUST AS SAME WAY AS ABOVE |

## USER ADJUSTABLE CONTROLS

## K. COLOR ADJUSTMENT

Press the "MODE" key then Main-Menu OSD come out as left below figure.


1) Search "COLOR" sub-menu using "UP/DOWN" key on the Main-Menu OSD.
2) Select the "COLOR" by pressing "SEL" key. Then The color Sub-Menu OSD comes out as right below figure.
3) Search "USER" using "UP/DOWN" key
("COLOR1" and "COLOR2" is adjusted in factory by auto-alignment machine)
4) Press "SELECT" key to adjust "RED","GREEN" and "BLUE" the each "RED","GREEN" and "BLUE" is selected by pressing the "SELECT" key and selected item changes OSD color from white to it's own color as character (ex: "RED" goes to red color)
5) Adjust "RED","GREEN" or "BLUE" using "UP/DOWN" key.
6) Press "MODE" key to finish the color adjustment then the OSD goes back to Main-Menu.
7) Press the "MODE" key again to finish the adjustment then the OSD disappear.
L. RECALL

When press the "RECALL" key, all user's adjustment Value are erased and covered by factory adjustment Value.
At first stage without any user's adjustment, The Monitor set-upped by factory adjustment value

## CONTROLS (VARIABLE RESISTORS)



The chassis of this monitor has been designed to emit a minimum of soft X-radiation, in accordance with US DHHS rules 21 CFR, subchapter. A high voltage shut-down circuit,
as shown below, guarantees horizontal oscillation shut-down should the high voltage exceed designed picture tube maximums. DO NOT ATTEMPT TO MODIFY THIS CIRCUIT. A fly back pulse is generated at pin (3) of the fly back transformer.

After the pulse converted to DC through rectifying circuit

D317 \& C338, In Normal Operation, 2.9 VDC impressed on MCU pin 36 with decreased voltage by R627 \& R637. But when High Voltageincreased more then 3.5 VDC, and it would be impressed on MCU pin 36, than pin 4(suspend) in MCU to be output from high to low, and IC pin 2 (+12VDC output) to be off and it has to be shut down.


## SEMICONDUCTORS


D305 .......... DIODE CHIP ................................ RLS4148

D307 …....... DIODE CHIP ................................ RLS4148
D310 …....... DIODE CHIP ................................... RLS4148
D312 .......... DIODE RECT-FAST ............ S3L60-4000
D313 .......... DIODE RECT-FAST ...................... 1N4937
D314 …....... DIODE CHIP ............................... RLS4148
D315 ........... DIODE CHIP .........................................................................................
D317 …....... DIODE RECT-FAST .................... 1N4937
D319 ........... DIODE CHIP ................................... RLS4148
D320 …....... DIODE RECT-FAST ........ SDS06F150S
D322 ........... DIODE CHIP .............................................. RLS4148
D398 .......... DIODE CHIP .................................. RLS4148
D399 ........... DIODE CHIP .................................... RLS4148
D401 ........... DIODE CHIP ................................... RLS4148
D402 .......... DIODE SW ...................................... 1SS244
D403 ........... DIODE SW ............................................ 1SS244
D404 ........... DIODE SW .......................................... 1 1SS244
D405 .......... DIODE SW .......................................... 1SS244
D406 .......... DIODE SW ...................................... 1SS244
D407 ........... DIODE SW ............................................ 1 SS244
D408 ........... DIODE SW ............................................ 1SS244
D409 ........... DIODE SW ............................................. 1 SS244
D410 …....... DIODE SW ............................................ 1 SS244
D412 ........... DIODE CHIP ................................. RLS4148

LOC. PARTS NAME SPECIFICATIONS

| D413 | DIODE CHIP | RLS4148 |
| :---: | :---: | :---: |
| D501 | DIODE CHIP | RLS4148 |
| D601 | LED | SAM3271 |
| D605 | IODE CHIP | RLS4148 |
| D606 | DIODE CHIP | RLS4148 |
| D608 | DIODE CHIP | RLS4148 |
| IC101 | IC POWER | STR-F6656 |
| IC102 | IC REGULATOR | KA278R05 |
| IC103 | IC REGULATOR | KA278R12 |
| IC104 | IC REGULATOR | KA431AZ |
| IC201 | IC DEFLECTION | KA2142 |
| IC301 | IC DEFLECTION | - TDA9109A |

IC302 ……. IC POWER ................................ KA7500B
IC403 …… IC OSD ………................... S5D2508AIC601 …… IC u-COM ……... KS88C6348(S3C863A)PC101 ....... IC PHOTO ......................... PC-17K1 CC
Q102 ….... TR NPN ….................................. KSR1009Q204 ........ TR NPN ...................................... KSR1009
Q305 ........ TR NPN ……......................... KSC3502-E
Q307 …… TR NPN …..................................... 2N3904
Q308 ........ TR NPN ........................................FJL6825
Q309 ........ TR NPN …….......................... KSC2328AQ311 ........ TR PNP ............................... KSA928A-Y
Q312 …… TR NPN CHIP …….... KSC1623-Y(C1Y)Q314 …… TR NPN CHIP ............ KSC1623-Y(C1Y)
Q317 …… FET ....................................... IRF650A(B)
Q319 ........ TR NPN ..................................... KSC5386
Q350 ....... TR NPN …….......................... KSC2328AQ352 …… FET ......................................... IRF640A(B)
Q353 ....... TR NPN ……........................... KSC2328AQ405 ........ TR PNP .................................... KSA992-F

## LOC. PARTS NAME

SEMICONDUCTORS


TRANSFORMERS, COIL

| BC101 ….. COIL-BEAD |  |
| :---: | :---: |
| BC301 -..... COIL-BEAD ........................... HC-3550 |  |
| BC307 -..... COIL-BEAD .......................... HC-3550 |  |
| BC402 ....... COIL-BEAD ............................. HC-3550 |  |
| BC403 ...... COIL-BEAD ............................ HC-3550 |  |
|  |  |
| BC405 - .-... COIL-BEAD ....).a. |  |
| BC406 ...... COIL-BEAD ............................ HC-3550 |  |
| BC407 ....... COIL-BEAD ............................ HC-3550 |  |
| F401 .......... FILTER-LC .................................. 22P |  |
| 402 …)..... FILTER-LC ................................... 22P |  |
| F403 - ......... FILTER-LC .... |  |
| L302 ……... COIL-BEAD ............................ HC-3550 |  |
| L303 -......... COIL-BEAD ............................. HC-3550 |  |
| L304 ......... COIL-CHOKE ............................. A85R |  |
| L305 ......... COIL-BEAD ........................... HC-3550 |  |
| L307 .......... COIL-CHOKE ............................ C110R |  |
| L601 .......... COIL-PEAKING AXIAL ... 100uH (AL02) |  |
| COIL-PEAK |  |

LOC. PARTS NAME SPECIFICATIONS


## RESISTORS

|  | CARBON FILM ............... 1/2W 1M J |
| :---: | :---: |
| R103 | R METAL OXIDE ................... 2W 100K |
|  | R CHIP .............................. 4.7K J 2012 |
|  | R CHIP ................................. 150 J 3216 |
| R107 | R CEMENT .... 2 W 0.22 J (MPR TYPE) |
| R107 | R CEMENT …ㅇ 2W 0.15 J (MPR TYPE) |
| R108 |  |
| R109 | R CEMENT .......... 2 W 68K J (R TYPE) |
| R110 | R CHIP .............................. 1K J 3216 |
| R111 | R CHIP .................................... 1K J 3216 |
| R112 | R CHIP .............................. 100K J 3216 |
| R113 | R METAL FILM ................. 1/4W 1.3K F |
| R1 | R CHIP ................................... 2 K J 3216 |
| R11 | R CHIP .................................. 20K J 3216 |
| R11 | R CHIP ................................. 4.7K J 3216 |
|  | R METAL OXIDE ................. 3 C 10K J |
|  | R METAL OXIDE .-.... 2 W 2 J (R TYPE) |
| R124 | R CHIP ............................... 4.7K J 2012 |
| R125 | R METAL OXIDE ..... 2W 22 J (SMALL) |
| R138 | R CHIP 1K J 3216 ……........ 1K J 3216 |
|  | R CHIP 220 J 3216 …......... 220 J 3216 |
| R197 | R METAL OXIDE …3W 10K J(R TYPE) |
| R198 | R METAL OXIDE ....)............ 3W 15 J |
|  | R CHIP .............................. 5.6K J 2012 |
|  | R METAL OXIDE ....................... 1 W 1 J |
| R206 | R CHIP ................................. 12K J 2012 |
| R207 | R CHIP ................................ 5.1K J 2012 |
| R208 | R CARBON FILM .-............. 1/2W 240 J |
| R209 | R METAL OXIDE ................. 1 W 0.82 J |
| R210 | R CARBON FILM ..................... 1/4W 1 J |
| R2 | R CHIP ................................. 30K J 2012 |
| R213 | R CHIP ................................. 4.7K J 3216 |
| R214 | R CHIP ................................ 10K J 2012 |

## RESISTORS



R321 ......... R METAL OXIDE .................... 1W 330 J
R322 …….. R CHIP ................................. 15K J 2012
R324 …...... R CHIP .................................. 470 J 3216
R325 …….. R CEMENT ............ 7W 470 J (R TYPE)
R326 …….. R CHIP ….............................. 100 J 3216
R327 …….. R CHIP .................................... 47K J 3216
R328 …….. R METAL OXIDE …….. 2W 3 J(SMALL)
R329 .......... CARBON FILM ........................ 1/4W 20 J
R330 ……... R METAL OXIDE ……2W 24 J(R TYPE)
R331 …...... R CHIP .................................... 1K J 2012
R333 …...... R METAL OXIDE ……2W 10 J (SMALL)
R336 …..... R CHIP ............................. 10 K J 2012
R337 …...... R CHIP ................................. 4.7K J 2012
R340 …….. R CHIP ................................... 15K J 3216
R341 ......... R CHIP ...................................... 1K J 3216
R346 …….. R METAL OXIDE … 2W 2.7 J (SMALL)
R347 …….. R CARBON FILM ……............. 1/2W 1 J
R348 ……... R CARBON FILM ................... 1/4W 47 J
R353 …….. R METAL OXIDE …2W 330 J (SMALL)
R354 …….. R CEMENT ...... 2W 0.33 J (MPR TYPE)
R355 …….. R CHIP ................................... 1M J 2012
R356 …….. R CHIP ...................................... 20K J 2012

LOC. PARTS NAME SPECIFICATIONS

|  |  |
| :---: | :---: |
| R358 …….... R CHIP .................................. 30K J 2012 |  |
| 360 ……... R METAL OXIDE ..................... 2W 1K J |  |
|  |  |
| R362 ……... R CHIP .............................. 10K J 2012 |  |
|  |  |
| R364 …….. R CHIP ............................ 360 J 2012 |  |
|  |  |
| R366 .......... R CHIP ................................ 3.3 K J 2012 |  |
|  |  |
| R368 …….. R CHIP ............................ 5.1K J 2012 |  |
| R369 ……... R CHIP ............................ 100K J 2012 |  |
| R370 ……... R CEMENT ..... 2 W 0.33 J (MPR TYPE) |  |
| R371 .......... R CHIP ............................. 4.7 K J 2012 |  |
| R372 .......... R CHIP ............................. 8.2K J 2012 |  |
| R373 .......... R CHIP ............................... 22K J 2012 |  |
| R374 ……... R CHIP ............................... 7.5 K J 2012 |  |
| R375 …....... R CHIP ................................ 4.7 K J 2012 |  |
| R377 .......... R CHIP ................................ 2K J 2012 |  |
|  |  |
| R379 .......... R CHIP ............................... 3.3K J 2012 |  |
| R380 .......... R CARBON FILM ................ 1/2W 10 J |  |
| R381 ……... R CHIP ................................ 8.2K J 2012 |  |
|  |  |
| R384 ……... R CARBON FILM …….............. 1/2W 1 J |  |
| R385 - .-....... R CARBON FILM |  |
|  |  |
| R401 ......... R CHIP ............................ 75 J 2012 |  |
|  |  |
|  |  |
| R408 ........... R CHIP ....................................... 2 W 2 J |  |
| 409 .......... R CHIP .................................. 100 J 3216 |  |
|  |  |
| 411 .......... R CHIP ................................. 100 J 3216 |  |
| 412 …)..... R CHIP ................................... 33 J 2012 |  |
| R413 .......... R CHIP ............................... 100 J 2012 |  |
| R414 ……... R CHIP ................................ 100 J 2012 |  |
| R415 .......... R CHIP ................................. 33 J 2012 |  |
| R416 .......... R CHIP ................................. 33 J 2012 |  |
| R417 .......... R CHIP ............................... 4.7K J 3216 |  |
| R418 .......... R CHIP .............................. 220K J 3216 |  |
| R419 |  |
| R420 …….. R CHIP .............................. 10 J 2012 |  |

## LOC. PAR RESISTORS

| 2 |  |
| :---: | :---: |
| 2 |  |
| $\ldots . . . . . . . . . . . . . . . . . . . . . . . . . ~ 390 ~ J ~ 2012 ~$ |  |
| $\ldots \ldots . . . . . . . . . . . . . . . . ~ 390 ~ J ~ 2012 ~$ |  |
| F FILM ................ 1/4W 2.2 J |  |
| 26 …...... R CHIP ................................... 100 J 2012 |  |
| 427 …....... R CHIP ................................... 100 J 2012 |  |
| 2 …...... R CHIP ..................................... 100 J 2012 |  |
| R CHIP .................................. 100 J 2012 |  |
| 4 …...... R CHIP ..................................... 100 J 3216 |  |
| R435 .......... R CHIP ..................................... 100 J 3216 |  |
|  | 100 J 3216 |

R437 ……... R CHIP ............................... 4.7 K J 3216
R438 …...... R CHIP ............................... 220K J 3216
R440 ……... R CHIP ................................... 62K J 2012
R441 …....... R CHIP .................................. 62K J 2012
R442 …...... R CHIP …............................... 910 J 2012
R445 ……... R CHIP ................................. 820K J 2012
R446 …...... R CHIP ................................. 820K J 2012
R447 ……... R CHIP ….............................. 820K J 2012
R448 ……... R CHIP ................................. 6.2K J 2012
R450 .......... R CARBON FILM ................... 1/4W 10 J
R451 …....... R CHIP ................................. 36K J 2012
R452 ……... R CHIP ................................... 100 J 2012
R453 ……... R CHIP …................................ 100 J 2012
R454 ……... R CHIP ……............................. 100 J 2012
R455 …- .... R CHIP …
R456 …...... R CHIP …................................ 200 J 2012
R457 …….... R CHIP .................................... 200 J 2012
R458 ……... R CHIP ................................. 200 J 2012
R460 …….. R CHIP …............................... 47 J 3216
R461 ……... R CHIP ….................................... 47 J 3216
R462 …....... R CHIP ...................................... 47 J 3216
R501 ……... R CHIP ................................... 100 J 3216
R502 …....... R CHIP .................................. 5.6K J 2012
R503 ……... R CHIP ............................... 100K J 2012
R504 ……... R CHIP ….............................. 240K J 2012
R505 ……... R CHIP .................................... 24K J 2012
R506 …....... R CHIP ................................. 2.4K J 2012
R507 …….... R CHIP ....................................33K J 2012
R508 …...... R CHIP ................................... 5.1K J 2012
R509 …...... R CHIP …............................... 91K J 3216

LOC. PARTS NAME SPECIFICATIONS
R510 …...... R CHIP ................................. 39 K J 3216
R511 ……... R CHIP ................................ 39 K J 3216


| R533 | 3.3K J 2012 |
| :---: | :---: |
| R536 | 68K J 2012 |

R537 …....... R CHIP ….............................. 120K J 3216

| R601 ......... R CHIP ............................... 2 C J 2012 |  |
| :---: | :---: |
| R602 | 100 J 2012 |




R610 ……... R CHIP …............................... 4.7K J 2012


R613 ……... R CHIP ................................... 100 J 2012




| R634 …… R CHIP ........................ 100 J 2012 |  |
| :---: | :---: |
|  |  |

R635 ……... R CHIP ..................................... 4.7K J 2012
R636 ……... R CHIP …................................ 56K J 2012
R637 ……... R CHIP ……
R638 ……... R CHIP ….............................. 8.2K J 2012
R639 ……... R METAL CHIP ................ 13.7K F 2012
R640 ……... R CHIP …...............................22K J 2012
R641 …....... R METAL CHIP ................. 2.55K F 2012
R642 …….. R CHIP ........................ 100 J 2012

R643 …...... R CHIP ................................. 100 J 2012

## LOC. PARTS NAME DESCRIPTION

|  |  |
| :---: | :---: |
|  | R654 ......... R CHIP .................................... 10K J 2012 |
|  | RL101 ....... RELAY .................................. DY313-D12S |
|  | RS601 ...... RESONATOR CRYSTAL ... 8.00MHz(HC-50/U) |
|  | VR301 ....... VR-SEMI ............................. NVZ 6 |
|  | VR501 ....... VR-SEMI .......................... NVZ 6THT |
|  | 502 …... VR-SEMI .......................... NVZ |
|  | VR503 ...... VR-SEMI ........................ NVZ 6THT 1 |

## CAPACITORS

|  | E ACROSS ....... AC 275V 0.22uF |
| :---: | :---: |
|  | ECTRO ............... 450V 330uF FUX |
|  | ELECTRO ....................... 50V 47uF RF |
|  | MYLAR ......................... 100V 4700pF J |
|  | MYLAR ............. NPP 630V 0.033uF J |
| C | CHIP ............................ F 0.1uF Z 2012 |
|  | ELECTRO ......................... 50V 1uF RF |
|  | ELECTRO .................... 16V 220uF RF |
|  | LINE ACROSS ....... AC 275V 0.22uF |
|  | MYLAR ............................ 100V 0.1uF J |
|  | ELECTRO ................ 100V 220uF RUS |
| C12 | ELECTRO ...................... 35V 470uF RF |
| C12 | ELECTRO ................ 100V 100uF RUS |
|  | ELECTRO ................. 160V 47uF RUS |
|  | CHIP ............................. B 100pF K 2012 |
|  | ELECTRO ................... 16V 1000uF RF |
| C12 | C ELECTRO ....................... 16V 47uF RF |
|  | C ELECTRO ................... 16V 2200uF RF |
|  | ELECTRO .................. 16V 2200uF RF |
| C203 | ELECTRO .................... 35V 220uF RF |
|  | MYLAR ........................ 100V 1500pF J |
| C | C MYLAR ....................... 100V 5600pF J |
| C | ELECTRO ................. 16V 2200uF RF |
|  | ELECTRO ....................... 50V 10uF RF |
| C208 | MYLAR ........................ MPE 63V 1uF J |
| C209 | C MYLAR ........................... 100V 0.01uF J |
|  | C MYLAR .................. MPE 200V 0.3uF J |
|  | C MYLAR .................... MPE 63V 0.1uF J |
|  | C MYLAR ......................... 100V 0.047uF J |
|  | MYLAR ........................ 100V 1500pF J |
|  | C CHIP .......................... B 1000pF K 2012 |
| C216 | ELECTRO .................... 16V 220uF RF |
| 30 | C ELECTRO ......................... 50V 1uF R |

LOC. PARTS NAME SPECIFICATIONS

| C305 ........... C MYLAR ............................ 100V 0.1uF J |  |
| :---: | :---: |
| 307 …….... C CHIP ........................... B 470pF K 2012 |  |
| 08 ........... C MYLAR ........................... 100V 0.1uF J |  |
| C309 ........... C MYLAR ............................ 100V 0.1uF J |  |
| C310 ........... C ELECTRO ..................... 16V 220uF RF |  |
| C311 ........... C MYLAR ........... NPPS 1.6KV 5300pF J |  |
| C312 ........... C ELECTRO .....................16V 100uF RF |  |
| F J |  |
| C315 ........... C ELECTRO ............... 100V 100uF RUS |  |
| C316 ........... C MYLAR ............... PFU 400V 0.20uF J |  |
| C318 ........... C MYLAR ............... MPP 250V 0.27uF J |  |
| C323 ........... C ELECTRO ..................... 16V 100uF RF |  |
| C324 …....... C CHIP ............................ F 0.1uF Z 2012 |  |
| C325 ........... C ELECTRO ....................... 16V 47uF RF |  |
| C326 …....... C MYLAR .......................... 100V 0.22uF J |  |
| C328 ........... C MYLAR ............... MPP 250V 0.47uF J |  |
| C329 ........... C MYLAR ............... MPP 250V 0.56uF J |  |
| C330 ........... C MYLAR ........................ 100V 6800pF J |  |
| C331 ........... C CHIP .......................... B 1000pF K 2012 |  |
| C332 ........... C MYLAR ......................... 100V 0.01uF J |  |
| C333 ........... C ELECTRO ...................... 50V 10uF RF |  |
| C334 ........... C MYLAR ....................... 100V 0.047uF J |  |
| C336 ........... C CHIP ........................... F 0.1uF Z 2012 |  |
| C337 ........... C ELECTRO .................... 16V 100uF RF |  |
| C338 ........... C ELECTRO ..................... 50V 10uF RF |  |
| C339 ........... C ELECTRO ...................... 50V 2.2uF RF |  |
| C340 ........... C CHIP ............................. F 0.1uF Z 2012 |  |
| C341 ........... C ELECTRO ................. 16V 1000uF RF |  |
| C342 ........... C MYLAR ................. MPE 63V 0.22uF J |  |
| C343 ........... C CHIP ............................ F 0.1uF Z 2012 |  |
| C344 ........... C ELECTRO ................... 16V 100uF RF |  |
| C345 ........... C MYLAR ................. MPE 63V 0.47uF J |  |
| C346 …....... C CHIP ........................... B 100pF K 2012 |  |
| C347 ............ C MYLAR ......................... 100V 1000pF J |  |
| C348 ........... C MYLAR ........................ 100V 0.022uF J |  |
| C349 ............ C MYLAR ............................ 100V 0.01uF J |  |
| C350 ........... C ELECTRO ...................... 50V 4.7uF RF |  |
| 351 ........... C MYLAR .......................... 100V 0.22uF J |  |
| C352 ........... C CHIP ............................. B 100pF K 2012 |  |
| C353 ........... C ELECTRO ........................ 50V 1uF RF |  |
| C354 ........... C ELECTRO ..................... 50V 3.3uF RF |  |
| C355 …........ C MYLAR .......................... 100V 1000pF J |  |
| . C ELECTRO ........................ 50V 47uF RF |  |


| LOC. | PARTS NAME | DESCRIPTION | LOC. | PARTS NAME | SPECIFICATIONS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| C357 | C MYLAR | 100V 3900pF J | C447 | C ELECTRO | $\cdots . . . . .16 \mathrm{~V}$ 100uF RF |
| C358 | C MYLAR | 100V 1000pF J | C449 | C MYLAR | $\cdots \cdots . . .100 \mathrm{~V} 0.1 \mathrm{uF}$ J |
| C359 | C ELECTRO | 50V 100uF RF | C450 | C MYLAR |  |
| C360 | C CHIP .......... | F 0.1uF Z 2012 | C451 | C MYLAR | $\cdots \cdots . . . . .100 \mathrm{~V} 0.1 \mathrm{uF}$ J |
| C362 | C MYLAR | 100V 0.012uF J | C452 | C MYLAR | $\cdots . . . . .100 \mathrm{~V} 0.01 \mathrm{uF} \mathrm{J}$ |
| C364 | C ELECTRO | 200V 10uF RUH | C453 | C MYLAR | $\cdots . . . . .100 \mathrm{~V} 0.01 \mathrm{uF}$ J |
| C365 | C MYLAR ...... | .. 100V 0.1uF J | C454 | C MYLAR | $\cdots . . . . .100 V ~ 0.01 u F ~ J ~$ |
| C366 | C ELECTRO | 50V 3.3uF RF | C460 | C CHIP | ..... B 47pF K 2012 |
| C370 | C CHIP .......... | 0.015uF K 2012 | C461 | C CHIP ... | ...... B 47pF K 2012 |
| C371 | C MYLAR ...... | U 400V 0.27uF J | C462 | C CHIP | ...... B 47pF K 2012 |
| C398 | C ELECTRO ... | 00V 220uF RUS | C463 | C CHIP ........ | ....... B 47pF K 2012 |
| C401 | C CHIP .......... | F 0.1uF Z 2012 | C501 | C ELECTRO | ..... 50V 10uF RND |
| C402 | C CHIP | F 0.1uF Z 2012 | C505 | C MYLAR | $\cdots \cdots . . . . .200 V ~ 0.1 u F ~ K ~$ |
| C404 | C ELECTRO | 16V 100uF RF | C601 | C ELECTRO | ......... 50V 10uF RF |
| C405 | C CHIP ............ | F 0.1uF Z 2012 | C603 | C CHIP ............ | -.... B 100pF K 2012 |
| C407 | C CHIP ......... | F 0.1uF Z 2012 | C605 | C ELECTRO | ............ 50V 10uF RF |
| C408 | C CHIP ............ | F 0.1uF Z 2012 | C608 | C ELECTRO | $\cdots \cdots . . . . . .50 V 10 u F ~ R F ~$ |
| C410 | C ELECTRO | 16V 100uF RF | C609 | C ELECTRO | ....... 16V 100uF RF |
| C413 | C ELECTRO | . 50V 1uF RF | C610 | C CHIP .......... | . F 0.01uF K 2012 |
| C414 | C ELECTRO | 50 V 10uF RF | C611 | C CHIP ........... | ...... F 0.1uF Z 2012 |
| C416 | C CHIP ......... | F 0.1uF Z 2012 | C612 | C CHIP ....... | -...... B 47pF K 2012 |
| C418 | C CHIP ......... | F 0.1uF Z 2012 | C613 | C CHIP .......... | ....... B 47pF K 2012 |
| C419 | C CHIP ........ | F 0.1uF Z 2012 | C614 | C CHIP ........ | ....... B 22pF K 2012 |
| C420 | C CHIP ..... | F 0.1uF Z 2012 | C615 | C CHIP | ...... B 22pF K 2012 |
| C421 | C CHIP ............ | F 0.1uF Z 2012 | C616 | C ELECTRO | $\cdots \cdots \cdots . . .16 \mathrm{~V}$ 220uF RF |
| C422 | C ELECTRO | 100V 22uF RUS | C617 | C CHIP ........... | ...... F 0.1uF Z 2012 |
| C423 | C MYLAR ....... | 100V 0.1uF J | C618 | C CHIP ...... | . B 1000pF K 2012 |
| C424 | C ELECTRO | . 50 V 1uF RUB | C619 | C CHIP ........... | ... B 1000pF K 2012 |
| C425 | C ELECTRO | 50 V 1 uF RUB | C621 | C CHIP ...... | ...... F 0.1uF Z 2012 |
| C426 | C ELECTRO | 50 V 1 uF RUB | C624 | C CHIP ....... | ...... F 0.1uF Z 2012 |
| C427 | C ELECTRO | 00V 4.7uF RUS | C699 | C CHIP ........ | ... B 1000pF K 2012 |
| C428 | C MYLAR ...... | 100V 0.1uF J | MISC | ANEOUS |  |
| C429 | C MYLAR | ..... 100V 0.1uF J |  |  |  |
| C430 | C MYLAR ....... | ..... 100V 0.1uF J | A001 | PCB MAIN | FR-4 282x197x1.6T |
| C431 | C MYLAR ........ | .. 100V 0.01uF J | A002 | PCB POWER | FR-4 230x166x1.6T |
| C434 | C ELECTRO | 16V 100uF RF | A005 | PCB NECK ... | FR-4 228x252x1.6T |
| C435 | C CHIP ............ | F 0.1uF Z 2012 | CRTG | WAFER ......... | ............ YFW800-01 |
| C436 | C CHIP ............ | F 0.1uF Z 2012 | F101 | FUSE | .... 50T 250V 3.15A |
| C437 | C ELECTRO .. | 16V 100uF RF | F101A | FUSE CLIP |  |
| C438 | C ELECTRO ... | 16V 100uF RF | G2 | WAFER ......... | ............ YFW800-01 |
| C441 | C CHIP .............. | F 0.1uF Z 2012 | M001 | CRT .................. | ........... A48KRD82X |
| C443 | C ELECTRO | 16V 1000uF RF | M002 | $\begin{aligned} & \text { COIL- } \\ & \text { DEGAUSSING } \end{aligned}$ | CD-0190A-10N |
| C444 | C MYLAR .......... | -.... 100V 0.1uF J |  |  |  |
| C445 | C ELECTRO | ... 16V 100uF RF | M003 | SIGNAL CABLE ... | SIGNAL CABLE 1.65M |



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